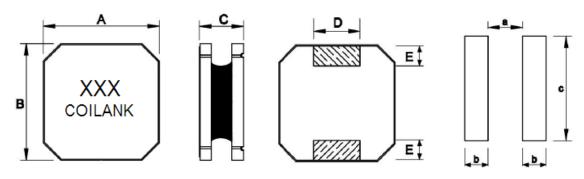


1. External Dimensions (Unit:m/m)



Type	Α	В	C	D	Е	а	b	С	Q'TY/Reel
ABG10A50	10.0±0.3	10.0±0.3	5.1Max	4.2Ref	1.7Ref	6.2Ref	2.0Ref	5.5Ref	700

2. Part Number Code

ABG 10 A 50 M 150 A B C D E F

A: Series Name Power Inductors
B: Dimensions(mm) 10: 10.0x10.0
C: Materials NO use
D: Thickness(mm) 50: 5.1 Max
E: Tolerance M: ±20%
F: Inductance 150=15uH

3. Electrical Characteristics

Part Number	Inductance (µH)	Test Frequency (KHz)	DC Resistance (mΩ)±30%	Heat Rating Current Irms (A)Typ.	Saturation Current Isat (A)Typ.	
ABG10A50M150	15.0	100KHz/1V	41.0	3.9	7.0	

Notes:

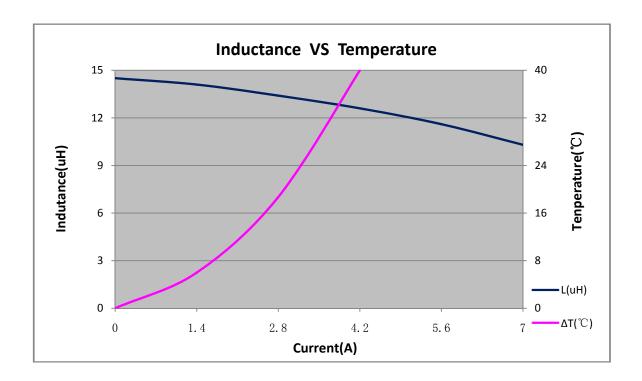
- a. All test data is referenced to 25°C ambient.
- b. Operating Temperature Range-40 $^{\circ}$ C to +125 $^{\circ}$ C.
- c. Irms :DC current(A) that will cause an approximate $\triangle T$ of 40°C.
- d. lsat :DC current(A) that will cause Lo to drop approximately 40%.
- e. The part temperature(ambient + temp rise)should not exceed 125°C under worst case operating conditions. Circuit design,component placement, PWB trace size and thickness,airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.



4. Test Data

Е	LECTRICA	L CHARCTE	MECHANICAL DIMENSIONS						
SPEC	L(uH)	DCR(mΩ)	Isat(uH)	A(mm)	B(mm)	C(mm)	D(mm)		
TOL	15.0	41.0	7.0A	10.0	10.0	5.1	4.2		
NO	±20%	±30%	(L0A-L7.0A) /L0A≤40%	±0.3	±0.3	Max	Ref		
1	14.59	49.17	10.39	10.04	9.98	4.85	OK		
2	14.82	38.82	10.63	9.97	10.01	4.84	OK		
3	14.37	49.24	10.16	10.01	10.02	4.86	OK		
4	14.44	38.95	10.25	10.02	9.98	4.87	OK		
5	14.15	49.36	10.01	10.04	9.97	4.85	OK		
6	14.74	49.28	10.57	9.98	10.03	4.86	OK		
7	14.10	38.71	10.02	9.98	10.01	4.86	OK		
8	14.42	49.19	10.27	10.02	10.00	4.87	OK		
9	14.17	48.83	10.00	10.00	9.99	4.83	OK		
10	14.24	49.20	10.05	10.01	10.01	4.84	OK		
Test Equip	Test Equipmets: IM3536,VR126,VR7210,Calipers								

Curve:





5. Test and Measurement Procedures

5.1 Test Conditions

5.1.1 Unless otherwise specified, the standard atmospheric conditions for measurement/test as:

a. Ambient Temperature: 20±15℃

b. Relative Humidity: 65%±20%

c. Air Pressure: 86KPa to 106KPa

5.1.2 If any doubt on the results, measurements/tests should be made within the following limits:

a. Ambient Temperature: 20±2℃

b. Relative Humidity: 65%±5%

c. Air Pressure: 86KPa to 106Kpa

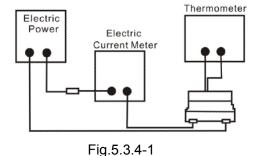
5.2 Visual Examination

a. Inspection Equipment: 10X magnifier

5.3 Electrical Test

- 5.3.1 Inductance (L)
 - a. Refer to the third item.
 - b. Test equipment: IM3536 LCR meter or equivalent.
 - c. Test Frequency and Voltage: Refer to the third item.
- 5.3.2 Direct Current Resistance (DCR)
 - a. Refer to the third item.
 - b. Test equipment: VR126 or equivalent.
- 5.3.3 Saturation Current (Isat)
 - a. Refer to the third item.
 - b. Test equipment: Saturation current meter
 - c. Definition of saturation current (Isat): DC current at which the inductance drops approximate 40% from its value without current.
- 5.3.4 Temperature rise current (Irms)
 - a. Refer to the third item.
 - b. Test equipment (see Fig.5.3.4-1): Electric Power, Electric current meter, Thermometer.
 - c. Measurement method (see Fig. 5.3.4-1):
 - 1. Set test current to be 0mA.
 - 2. Measure initial temperature of choke surface.
 - 3. Gradually increase current and measure choke temperature for corresponding current.
 - 4. Definition of Temperature rise current: DC current that causes the temperature rise ($\triangle T$ =40°C) from 20°C ambient (see Fig. 5.3.4-2).

RT+_AT



0 I I I I I Rated current

Fig.5.3.4-2

Idc(A)



5.4 Reliability Test

Items	Required Characteristics	Test Method/Condition		
5.4.1 Solder Ability Test	① 90% or more of electrode area shall be Coated by new solder.	 ① After fluxing, component shall be dipped in a melted. ② Solder: bath at 235°C±5°C for 5±0.5 seconds Preheating Dipping Natural cooling 235°C		
		150℃ second 5±0.5 second ① Preheat:150±5°C 60seconds. ② Solder temperature: 255±5°C. ③ Flux: rosin.		
5.4.2 Heat endurance of Soldering	No visible mechanical damage. Inductance change: Within ±10% Impedance change: Within ±10%	4 Dip time: 3seconds Max Preheating Dipping Natural cooling 150°C second 3seconds Max		
5.4.3 Electrode Strength Test	① After soldering of X, Y withstanding at below conditions .The terminal should not Peel off.			
5.4.4 Vibration Test	Inductance change: Within ± 10% Without mechanical damage such as Break	 Vibration frequency: (10 Hz to 55 Hz to 10Hz) in 60 seconds as a period Vibration time: Period cycled for 2 hours in each of 3 mutual perpendicular directions. Amplitude: 1.5 mm max. 		
5.4.5 Drop test	① △L≦±10.0% change from an initial value	① Drop specimen three times on concrete floor from a height 0f 1 meter which mounted on test board.		



Items	Required Characteristics	Test Method/Condition
5.4.6 High Temperature StorageTest	 ① No case deformation or change in appearance ② △L/L≤10% ③ △Q/Q≤30% ④ △DCR/DCR≤10% 	① Temperature:125°C±5°C Time:500±2 hours. ② Tested not less than 1 hour, nor more than 2 hours at room. Temp 125°C High temperature 25°C 0°C High temperature 500H Test Time
5.4.7 Low Temperature Storage Test	 No case deformation or change in appearance △L/L≤10% △Q/Q≤30% △DCR/DCR≤10% 	① Temperature:-40°C±2°C Time:500±2 hours. ② Tested not less than 1 hour, nor more than 2 hours at room. 25°C Tested not less than 1 hour, nor more than 2 hours at room.
5.4.8 Humidity Resistance Test	 ① No case deformation or change in appearance ② △L/L≤10% ③ △Q/Q≤30% ④ △DCR/DCR≤10% 	① Environment condition: 85 ± 2 °C ② Humidity: 80–85% ③ Applied Current: Rated current ④ Duration: 500 + 4 / -0 hours ⑤ Tested not less than 1 hour, nor more than 2 hours at room.
5.4.9 Thermal Shock Test	 ① No case deformation or change in appearance. ② △L/L≤10% ③ △Q/Q≤30% ④ △DCR/DCR≤10% 	① Repeat 100 cycles as follow: (-40 ± 3 °C; 30 ± 3 min) → (Room temp; 2 min) → (+125 ± 2 °C, 30 ± 3 min) → (Room temp; 2 min) ② Recovery: 1-2 hours of recovery under the standard condition after the test. Temp 125℃ Change time < 2Min Time -40℃

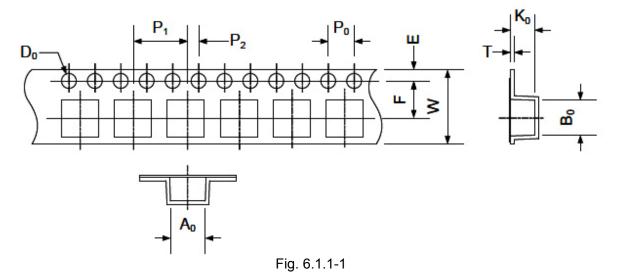


6. Packaging, Storage

6.1 Tape and Reel Packaging Dimensions

6.1 .1 Taping Dimensions (Unit: mm)

Please refer to Fig. 6.1.1-1



TYPE Α0 B0 W Ε P0 P1 P2 D0 Т K0 1.5±0.1 10.5±0.1 24.0±0.3 1.75±0.1 11.5±0.1 5.3±0.1 ABG10A50 10.5±0.1 4.0±0.1 16.0±0.1 2.0±0.1 0.4±0.1

6.1.2 Direction of rolling

Please refer to Fig. 6.1.2-1.

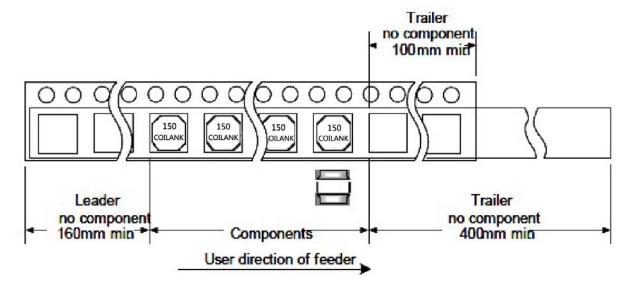


Fig. 6.1.2-1.



6.1.3 Reel Dimensions (Unit: mm)

Please refer to Fig. 6.1.3-1.

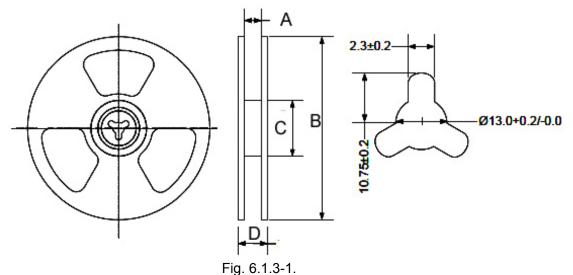


Fig. 6. 1.3-1.

TYPE	Α	В	С	D
ABG10A50	24.5±2.0	330.0±2.0	100.0±2.0	28.5±2.0

6.2 Packaging

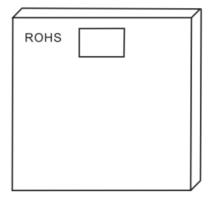
6.2.1 The inner box specification: 350*340*40MM

Packing quantity: 700PCS/ box

Bubble bag: 37*45CM

Job description: putting the air bubble bag products placed

inside the box, sealed with scotch tape



6.2.2 The outside box specification: 370*360*255MM

Packing quantity: 2100PCS/ box

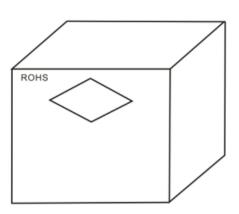
Job description: will be outside the box bottom

sealed, inner box into the box.

a. With transparent tape sealed box at the top

b. The specified location with a box labels in the outer box.

c. If the mantissa box under a FCL with inner box or filling full





6.3 Storage

- a.To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.
- b. Recommended conditions: -10°C~40°C, 70%RH (Max.)
- c.The ambient temperature must be kept below 30℃.Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used with one year from the time of delivery.
- d. In case of storage over 6 months, solderability shall be checked before actual usage.

7. Recommended Soldering Technologies

7.1 Re-flowing Profile:

△ 1~2 °C/sec. Ramp

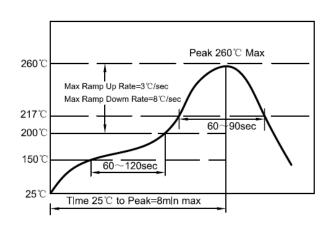
△ Pre-heating: 150~190°C/90±30 sec.

∆ Time above 240°C: 20~40sec

△ Peak temperature: 255°C Max./5sec;

△ Solder paste: Sn/3.0Ag/0.5Cu

△ Max.2 times for Re-flowing



7.2 Iron Soldering Profile:

△ Iron soldering power: Max.30W

△ Pre-heating: 150°C/60sec.

△ Soldering Tip temperature: 350 °C Max.

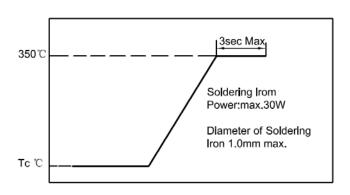
 \triangle Soldering time: 3sec Max.

△ Solder paste: Sn/3.0Ag/0.5Cu

△ Max.1 times for iron soldering

[Note: Take care not to apply the tip of the

soldering iron to the]



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MHQ1005P3N6S MHQ1005P5N1S MHQ1005P8N2J PE-51506NL PE-53601NL PE-53602NL PE-53630NL PE-53824SNLT PE-92100NL

PG0434.801NLT PG0936.113NLT 9220-20 9310-16 PM06-2N7 PM06-39NJ A01TK 1206CS-471XJ HC2LP-R47-R HC2-R47-R HC32R2-R HCF1305-3R3-R 1206CS-151XG RCH664NP-140L RCH664NP-4R7M RCH8011NP-221L RCP1317NP-332L RCP1317NP-391L